2SB1027

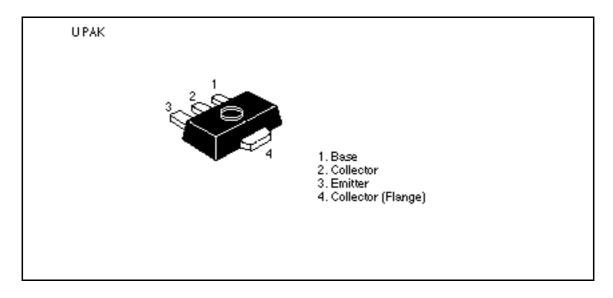
Silicon PNP Epitaxial

HITACHI

Application

Low frequency amplifier

Outline





2SB1027

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	-180	V
Collector to emitter voltage	V _{CEO}	-120	V
Emitter to base voltage	V_{EBO}	- 5	V
Collector current	I _c	-1.5	А
Collector peak current	i _{C(peak)} *1	-3	А
Collector power dissipation	P _c * ²	1	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW 10 ms, Duty cycle 20%

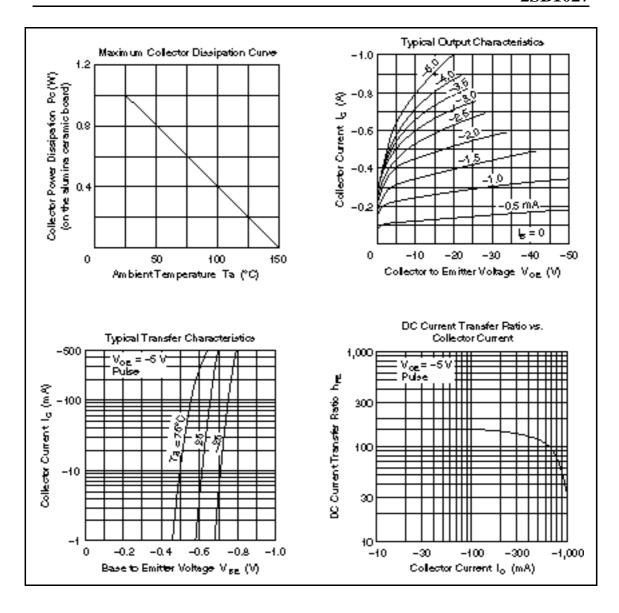
2. Value on the alumina ceramic board (12.5 \times 20 \times 0.7 mm)

Electrical Characteristics ($Ta = 25^{\circ}C$)

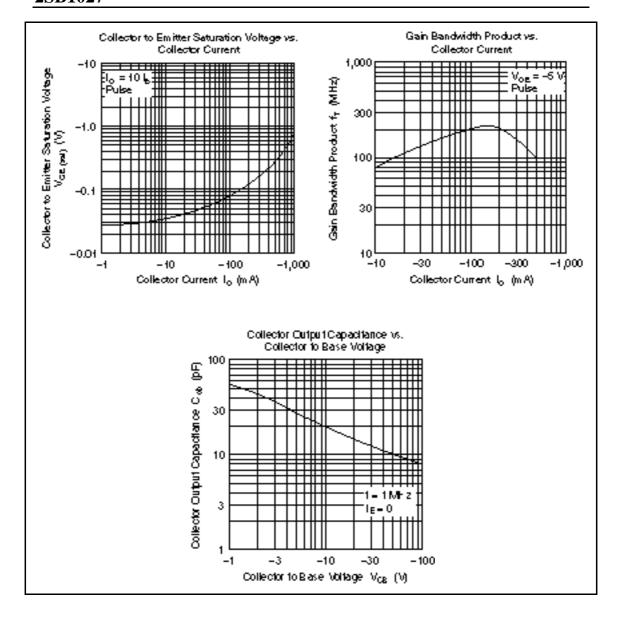
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\text{(BR)CBO}}$	-180	_	_	V	$I_{c} = -1 \text{ mA}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-120	_	_	V	$I_{c} = -10 \text{ mA}, R_{BE} =$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	- 5	_	_	V	$I_{\rm E} = -1 \text{mA}, I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	-10	μΑ	$V_{CB} = -160 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE1} *1	60	_	320		$V_{CE} = -5 \text{ V}, I_{C} = -0.15 \text{ A},$ pulse
	h _{FE2}	30	_	_		$V_{CE} = -5 \text{ V}, I_{C} = -0.5 \text{ A},$ pulse
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-1.0	V	$I_{\rm C} = -0.5 \; {\rm A}, \; I_{\rm B} = -50 \; {\rm mA}, \; {\rm Pulse}$
Base to emitter voltage	V_{BE}	_	_	-0.9	V	$V_{CE} = -5 \text{ V}, I_{C} = -0.15 \text{ A},$ pulse

Note: 1. The 2SB1027 is grouped by h_{FE1} as follows.

Mark	EH	EJ	EK
h _{FE1}	60 to 120	100 to 200	160 to 320



2SB1<u>027</u>



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